

2SK1515, 2SK1516

Silicon N Channel MOS FET

REJ03G0946-0200

(Previous: ADE-208-1286)

Rev.2.00 Sep 07, 2005

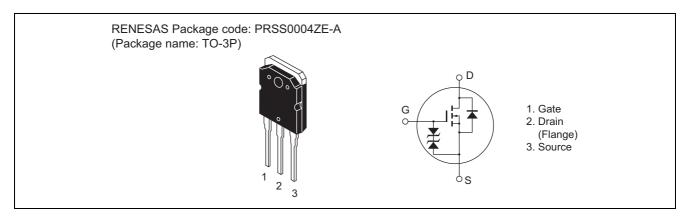
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- Built-in fast recovery diode ($t_{rr} = 120 \text{ ns}$)
- Suitable for motor control, switching regulator, DC-DC converter

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1515	V_{DSS}	450	V
	2SK1516		500	
Gate to source voltage		V_{GSS}	±30	V
Drain current		I _D	10	A
Drain peak current		I _{D(pulse)} *1	30	A
Body to drain diode reverse drain current		I _{DR}	10	A
Channel dissipation		Pch*2	100	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $T_C = 25$ °C

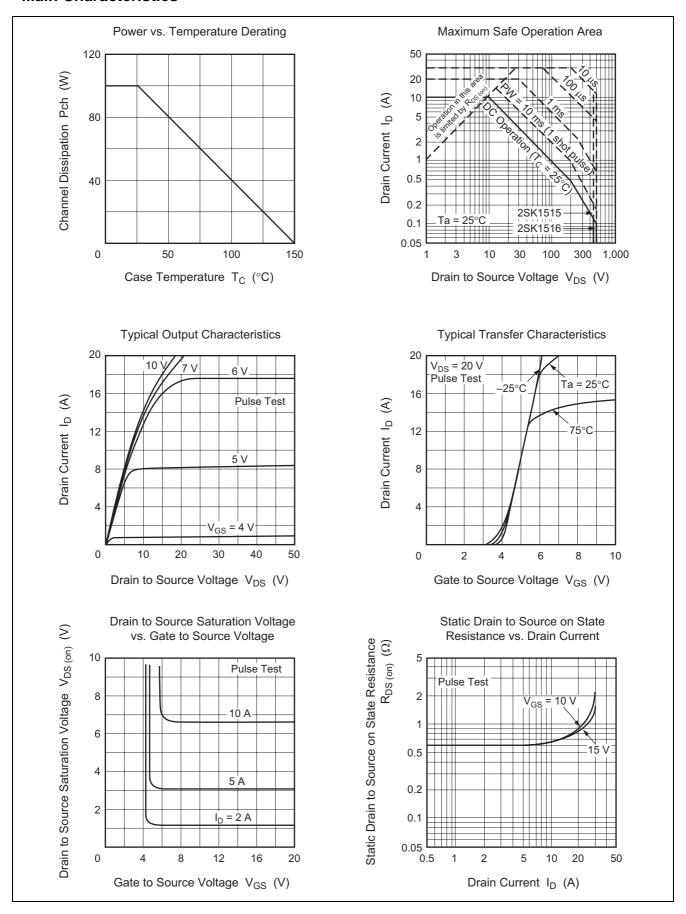
Electrical Characteristics

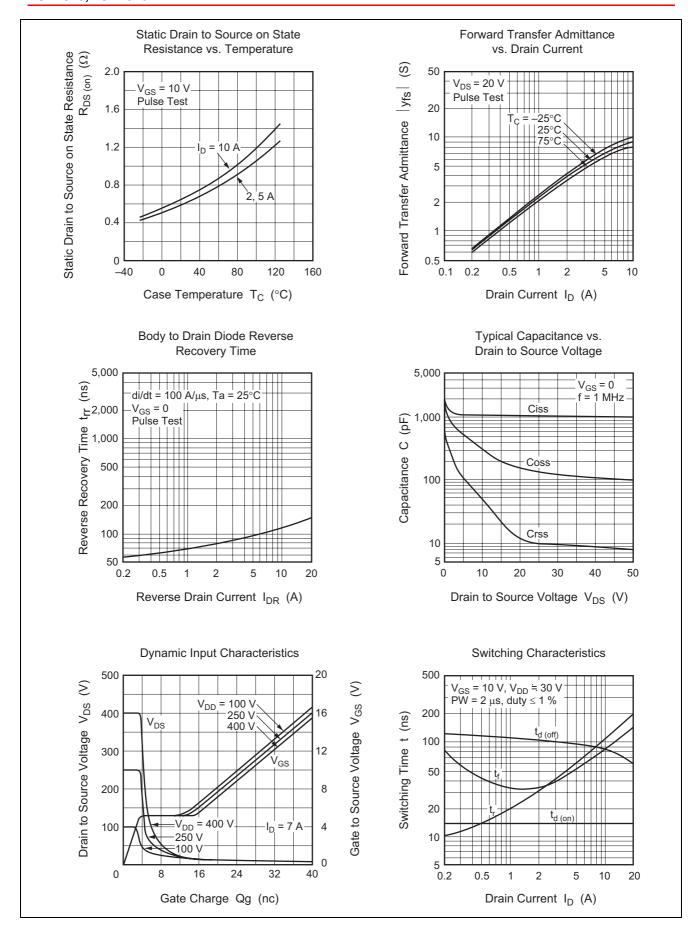
 $(Ta = 25^{\circ}C)$

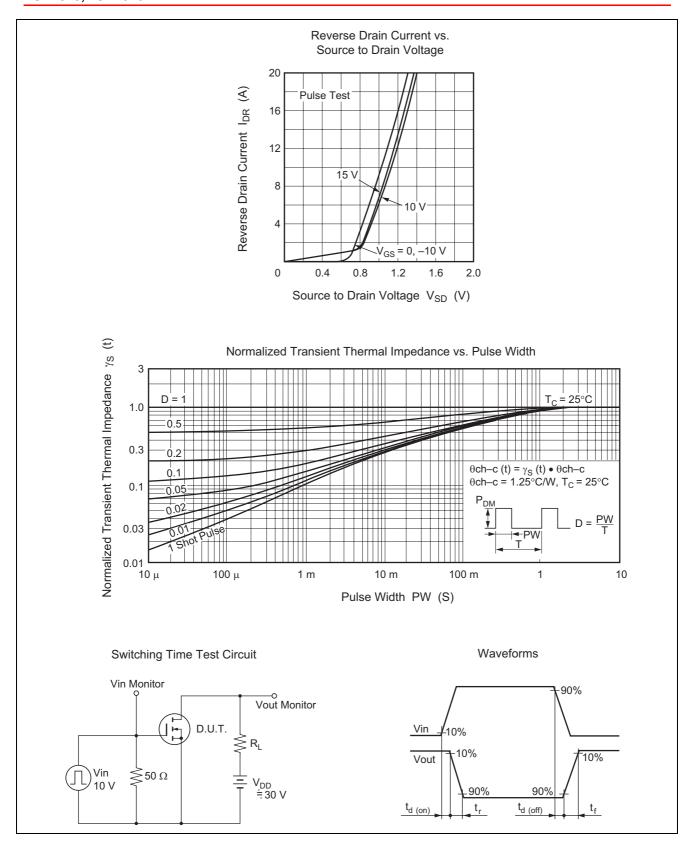
Item		Symbol	Min	Тур	Max	Unit	Test conditions	
Drain to source	2SK1515	V _{(BR)DSS}	450	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
breakdown voltage	2SK1516		500					
Gate to source breakdow	Gate to source breakdown voltage		±30	1	1	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$	
Gate to source leak current		I_{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$	
Zero gate voltage drain	2SK1515	I _{DSS}	_	_	250	μΑ	$V_{DS} = 360 \text{ V}, V_{GS} = 0$	
current	2SK1516						$V_{DS} = 400 \text{ V}, V_{GS} = 0$	
Gate to source cutoff voltage		$V_{GS(off)}$	2.0	1	3.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$	
Static drain to source on	2SK1515	R _{DS(on)}	_	0.6	0.8	Ω	$I_D = 5 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$	
state resistance	2SK1516		_	0.7	0.9			
Forward transfer admittance		y _{fs}	4.0	7.0	_	S	$I_D = 5 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$	
Input capacitance		Ciss	_	1100	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$	
Output capacitance		Coss	_	310	_	pF	f = 1 MHz	
Reverse transfer capacitance		Crss	_	50	_	pF		
Turn-on delay time		t _{d(on)}	_	15	_	ns	$I_D = 5 \text{ A}, V_{GS} = 10 \text{ V},$	
Rise time		t _r	_	65	_	ns	$R_L = 6 \Omega$	
Turn-off delay time		$t_{d(off)}$	_	95	_	ns		
Fall time		t _f	_	55	_	ns		
Body to drain diode forward voltage		V_{DF}	_	1.0	_	V	I _F = 10 A, V _{GS} = 0	
Body to drain diode reverse recovery		t _{rr}	_	120	_	ns	$I_F = 10 \text{ A}, V_{GS} = 0,$	
time							$di_F/dt = 100 A/\mu s$	

Note: 3. Pulse test

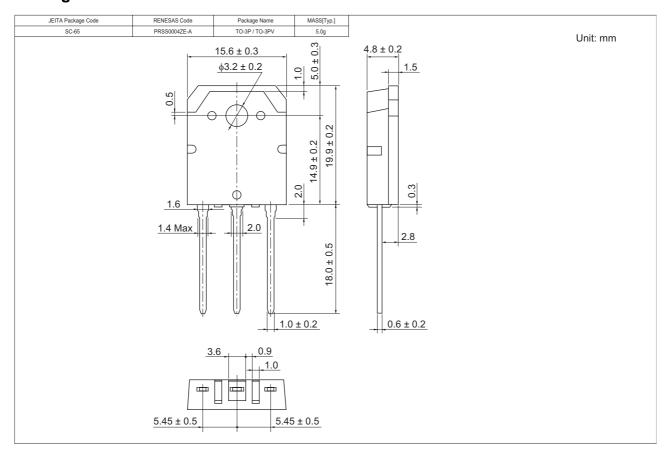
Main Characteristics







Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container		
2SK1515-E	360 pcs	Box (Tube)		
2SK1516-E	360 pcs	Box (Tube)		

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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